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May 2001

FDS4501H Complementary PowerTrench[®] Half-Bridge MOSFET

General Description

This complementary MOSFET half-bridge device is produced using Fairchild's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

Applications

- DC/DC converter
- Power management
- · Load switch
- · Battery protection

Features

Q1: N-Channel

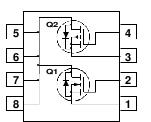
9.3A, 30V

- $$\begin{split} \text{R}_{\text{DS(on)}} &= 18 \text{ m}\Omega \text{ @ } \text{V}_{\text{GS}} = 10\text{V} \\ \text{R}_{\text{DS(on)}} &= 23 \text{ m}\Omega \text{ @ } \text{V}_{\text{GS}} = 4.5\text{V} \end{split}$$
- Q2: P-Channel

–5.6A, –20V

$$\begin{split} \mathsf{R}_{\mathsf{DS}(\mathsf{on})} &= 46 \text{ m}\Omega \ @ \mathsf{V}_\mathsf{GS} = -4.5\mathsf{V} \\ \mathsf{R}_{\mathsf{DS}(\mathsf{on})} &= 63 \text{ m}\Omega \ @ \mathsf{V}_\mathsf{GS} = -2.5\mathsf{V} \end{split}$$





Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Q1	Q2	Units
V _{DSS}	Drain-Sourc	e Voltage		30	-20	V
V _{GSS}	Gate-Source	e Voltage		±20	±8	V
D	Drain Currer	nt - Continuous	(Note 1a)	9.3	-5.6	A
		- Pulsed		20	-20	
PD	Power Dissi	pation for Single Operation	(Note 1a)	2	.5	W
			(Note 1b)	1	.2	
			(Note 1c)		1	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		ature Range	-55 to +150		°C
Therma	I Charact	eristics				
R _{0JA}	Thermal Resistance, Junction-to-Ambient (Note 1a)		nt (Note 1a)	50		°C/W
R _{0JC}	Thermal Resistance, Junction-to-Case (Note 1)		(Note 1)	2	°C/W	
Packag	e Marking	g and Ordering Inf	ormation			
Device Marking			Reel Size	Tape wi	dth	Quantity
FDS4	501H	FDS4501H	13"	12mm	ı	2500 units

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Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$ $V_{GS} = 0 V, I_D = -250 \mu A$	Q1 Q2	30 –20			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C $I_D = -250 \ \mu\text{A}$, Referenced to 25°C	Q1 Q2		24 -13		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$ $V_{DS} = -16 V, V_{GS} = 0 V$	Q1 Q2			1 _1	μA
GSS	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ $V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	Q1 Q2			<u>+</u> 100 <u>+</u> 100	nA
On Char	racteristics (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{DS} = V_{GS}, I_D = -250 \ \mu A$	Q1 Q2	1 0.4	1.6 0.7	3 –1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate Threshold Voltage Temperature Coefficient	$l_{\rm b}$ = 250 µA, Referenced to 25°C $l_{\rm b}$ = –250 µA, Referenced to 25°C	Q1 Q2		-4 3		mV/ºC
R _{DS(on)}	Static Drain-Source On-Resistance		Q1 Q2		14 21 17 36 49	18 29 23 46 80	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = -2.5 \text{ V}, _{D} = -5.0 \text{ A}$ $V_{GS} = 10 \text{ V}, _{DS} = 5 \text{ V}$	Q1	20	47	63	А
D(01)		$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	Q2	-20			
g fs	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 9.3 A$ $V_{DS} = 5 V$, $I_D = -5.6 A$	Q1 Q2		28 16		S
Dynamie	c Characteristics						
Ciss	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz	Q1 Q2		1958 1312		pF
Coss	Output Capacitance		Q1 Q2		424 240		pF
C _{rss}	Reverse Transfer Capacitance		Q1 Q2		182 106		pF

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Мах	Units
Switchir	g Characteristics (Note	2)					
t _{d(on)}	Turn-On Delay Time	Q1 $V_{DD} = 15 V, I_D = 1 A,$	Q1 Q2		15 15	27 27	ns
tr	Turn-On Rise Time	$V_{GS} = 10V, R_{GEN} = 6 \Omega$ Q1	Q1 Q2		5 15	10 27	ns
t _{d(off)}	Turn-Off Delay Time	$V_{DD} = -10 \text{ V}, \text{ I}_D = -1 \text{ A},$ $V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$	Q1 Q2		38 40	61 64	ns
t _f	Turn-Off Fall Time		Q1 Q2		10 25	20 40	ns
Q _g	Total Gate Charge	Q1 V _{DS} = 15 V, I _D = 9.3 A, V _{GS} = 4.5 V	Q1 Q2		17 13	27 21	nC
Q _{gs}	Gate-Source Charge	Q2	Q1 Q2		4 2.5		nC
Q _{gd}	Gate-Drain Charge	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = -2.4 \text{ A}, \text{V}_{GS} = -4.5 \text{ V}$	Q1 Q2		5 2.0		nC
Drain-Sc	ource Diode Characteri	stics and Maximum Batings					
ls	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current					2.1 2.1	A
V _{SD}	Drain-Source Diode Forwarc Voltage		Q1 Q2			1.2 -1.2	V
otes:							





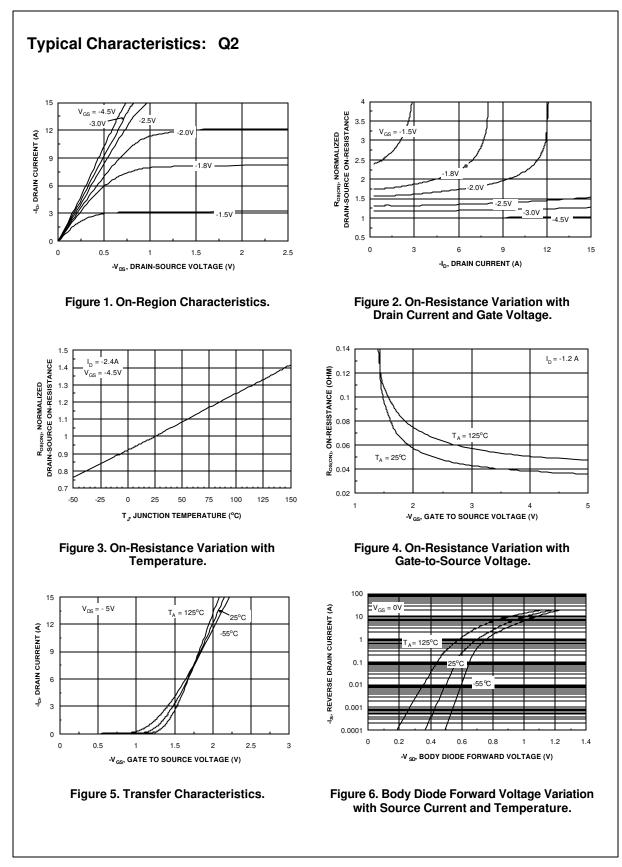
b) 105°C/W when mounted on a 0.04 in² pad of 2 oz copper

с

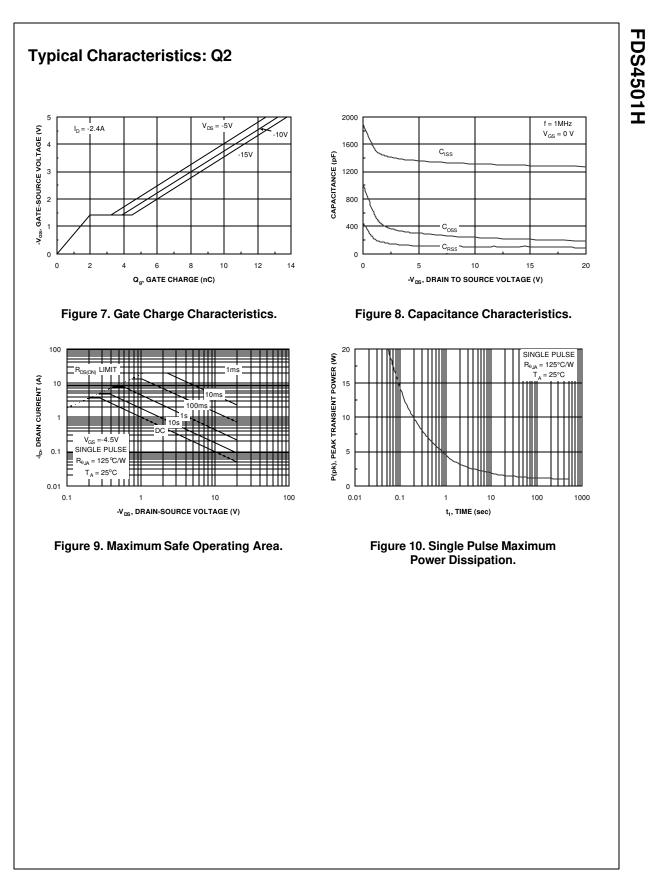
c) 125°C/W when mounted on a minimum pad.

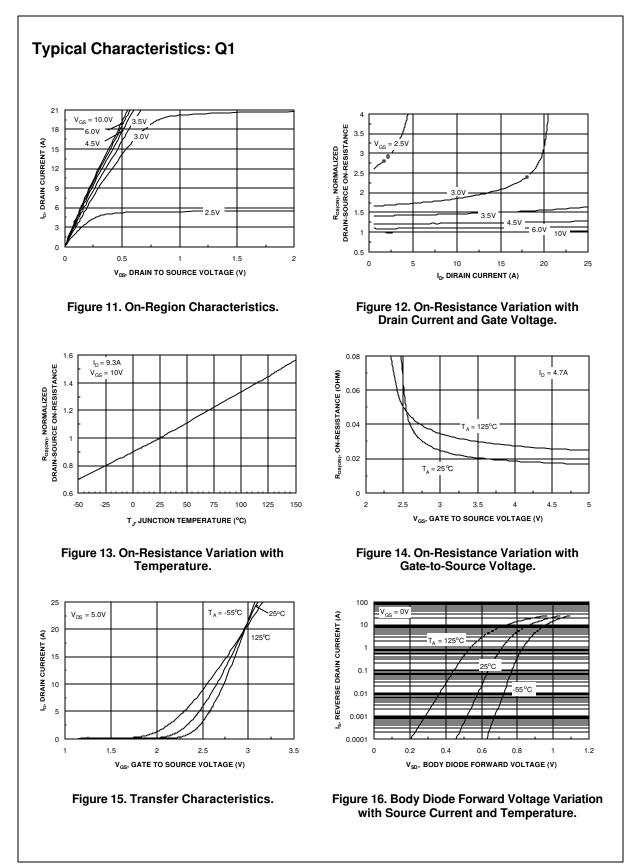
Scale 1 : 1 on letter size paper

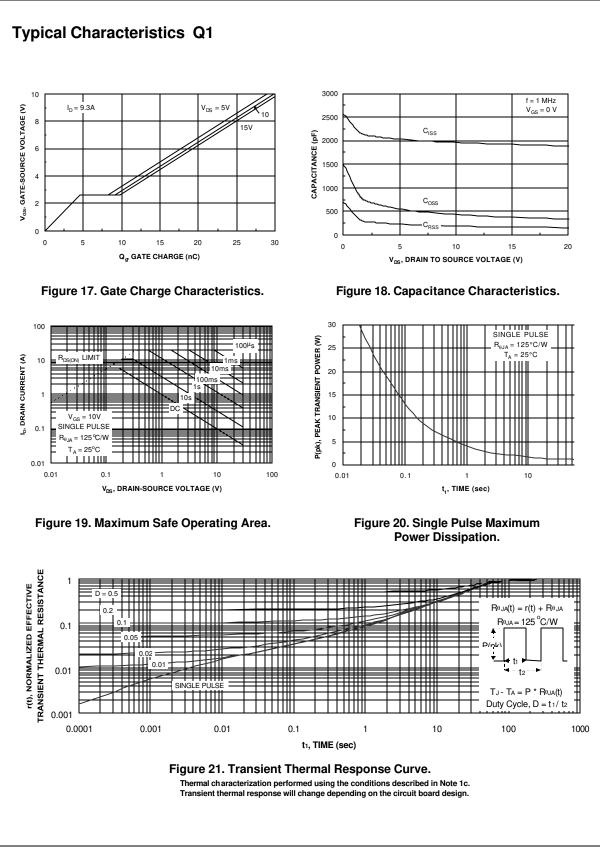
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%



FDS4501H Rev C(W)







FDS4501H Rev C(W)

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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